

*East search for paper no. 11/05*

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	577	(438/4,406).CCLS.	USPAT	OR	OFF	2005/11/07 15:47
L2	1585	(438/455-459).CCLS.	USPAT	OR	OFF	2005/11/07 15:47
L3	742	(438/471-477).CCLS.	USPAT	OR	OFF	2005/11/07 15:47
L4	1818	(438/692).CCLS.	USPAT	OR	OFF	2005/11/07 15:48
L5	1248	(438/795-799).CCLS.	USPAT	OR	OFF	2005/11/07 15:48
L6	849	(438/974,977).CCLS.	USPAT	OR	OFF	2005/11/07 15:48
L7	183	(117/2).CCLS.	USPAT	OR	OFF	2005/11/07 15:48
L8	0	(156/610).CCLS.	USPAT	OR	OFF	2005/11/07 15:39
L9	0	(156/610.cior.).CCLS.	USPAT	OR	OFF	2005/11/07 15:41
L10	68	156/610.cior.	USPAT	OR	OFF	2005/11/07 15:46
L11	253	156/610.cixr.	USPAT	OR	OFF	2005/11/07 15:48
L12	0	156/610.cior.	US-PGPUB; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/07 15:46
L13	0	156/610.cixr.	US-PGPUB; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/07 15:46
L14	960	(438/4,406,455-459).CCLS.	US-PGPUB; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/07 15:48
L15	1335	(438/471-477,692).CCLS.	US-PGPUB; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/07 15:48
L16	2432	(438/795-799,974,977).CCLS.	US-PGPUB; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/07 15:47
L17	1947	(438/795-799).CCLS.	US-PGPUB; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/07 15:48

L18	502	(438/974,977).CCLS.	US-PGPUB; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/07 15:48
L19	282	(117/2).CCLS.	US-PGPUB; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/07 15:48

Interference search for paper no. 11/05

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	141	((process method) and substrate and (annealing heating) and surface and (reductive hydrogen reducing) and (cmp polishing)). clm.	US-PGPUB	OR	ON	2005/11/07 15:53